

(3)



**COMBINED DECLARATION AND POWER OF ATTORNEY
FOR UTILITY PATENT APPLICATION**

As a below-named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention titled:

Apparatus and process for precise encapsulation of flip chip interconnects

the specification of which

- is attached hereto.
- was filed on February 22, 2002 as Application No. 10/081,425,
- and was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a) which states in relevant part: "Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section....The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§ 1.97(b)-(d) and 1.98."

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate as indicated below and have also identified below any foreign application for patent or inventor's certificate on this invention having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)	Priority Claimed	
(Number) (Country) (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
(Number) (Country) (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), and under Title 35, United States Code, § 119(e) of any United States provisional application(s), listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

60/272,280	27 February 2001	Pending (Status: Patented, Pending, Abandoned)
(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
(Application No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, and to file, prosecute and to transact all business in connection with international applications directed to said invention:

Mark A. Haynes	Reg. No. 30,846
Ernest J. Beffel, Jr.	Reg. No. 43,489
Warren S. Wolfeld	Reg. No. 31,454
James F. Hann	Reg. No. 29,719
Bill Kennedy	Reg. No. 33,407

Address all correspondence to:

CUSTOMER NO. 22470

Bill Kennedy
Haynes Beffel & Wolfeld LLP
P.O. Box 366
Half Moon Bay, CA 94019

Direct all telephone calls to Bill Kennedy at (650) 712-0340.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of **sole or first**
inventor, if any: Rajendra Pendse

Inventor's signature: M. Pendse

Date: _____

Citizenship: US

Mailing Address: 5245 Diamond Common

Fremont, CA 94555

Residence: same as above

COPY



Form PTO-1595
(Rev. 03/01)
OMB No. 0651-0027 (exp. 5/31/2002)

**RECORDATION FORM COVER SHEET
PATENTS ONLY**

U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Rajendra Pendse

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

<input checked="" type="checkbox"/> Assignment	<input type="checkbox"/> Merger
<input type="checkbox"/> Security Agreement	<input type="checkbox"/> Change of Name
<input type="checkbox"/> Other _____	

April 11, 2002

Execution Date: _____

2. Name and address of receiving party(ies)

Name: **ChipPAC, Inc.**

Internal Address: _____

Street Address: **47400 Kato Road**

City: **Fremont** State: **CA** Zip: **94538**

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) **10/081,425**

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Bill Kennedy**

Internal Address: _____

Haynes Beffel & Wolfeld LLP

Street Address: **P.O. Box 366**

City: **Half Moon Bay** State: **CA** Zip: **94019**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41).....\$ **40.00**

Enclosed

Authorized to be charged to deposit account

8. Deposit account number: **50-0869**

Attorney Docket No.: **CPAC 1011-2**

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Bill Kennedy
Name of Person Signing

Signature

May 1, 2002

Date

Total number of pages including cover sheet, attachments, and documents: **6**

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

COPY OF PAPERS
O I P E

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, the undersigned, Rajendra Pendse of Fremont, California (hereinafter termed the "Inventor") is the inventor of the invention described and set forth in the United States Patent Application titled:

Apparatus and process for precise encapsulation of flip chip interconnects

and has executed an oath or declaration of inventorship for said application, the said application having been filed in the United States Patent and Trademark Office on February 22, 2002 as U.S. Application No. 10/081,425 (hereinafter termed the "Application"); and

WHEREAS, ChipPAC, Inc., a corporation of the state of Delaware, having a place of business at 47400 Kato Road, Fremont, California 94538 (hereinafter termed the "Assignee") is desirous of acquiring the entire right, title and interest in and to the Application and the invention disclosed therein, and in and to any and all embodiments of the invention, heretofore conceived, made, or discovered jointly or severally by said Inventor (all collectively hereinafter termed the "Invention") and in and to any and all patents, inventors' certificates, and other forms of protection (hereinafter termed the "Patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged by the Inventor:

1. The Inventor has assigned to the Assignee, and does hereby sell, assign, transfer and convey to the Assignee all right, title and interest (a) in and to the Invention and the Application; and (b) in and to all rights to apply for foreign patents (including patent, utility model and industrial designs) on the Invention pursuant to the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the Application; and (c) in and to any and all applications filed and any and all patents granted on the Invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extension of any of said patents.

2. The Inventor hereby agrees to cooperate with the Assignee to enable the Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by the Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by the Assignee (a) for perfecting in the Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering the Invention; (d) for filing and prosecuting applications for reissuance of any said Patents; (e) for interference or other priority proceedings involving the Invention; and (f) for legal proceedings involving the Invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by the Inventor in providing such cooperation shall be paid for by the Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representatives, and shall be binding upon the Inventor, his respective heirs, legal representatives and assigns.

4. The Inventor hereby warrants and represents that he has not entered into and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the Inventor has executed and delivered this instrument to the Assignee as of the date written below.

Murse
Rajendra Pendse

Date

4/11/02

State of CALIF.

County of ALAMEDA

On APRIL 11, 2002, before me, JAMES GALLAGHER, Notary
personally appeared RAJ PENDSE

personally known to me or proved to me on the basis of satisfactory evidence, to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person or the entity upon behalf of which the person acted, executed the instrument.

WITNESS my hand and official seal.

James Gallagher
(Notary Public)